

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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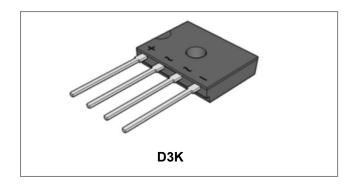








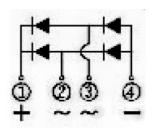
UG4KB05 THRU UG4KB100 Single-Phase 4.0A Glass Passivated Bridge Rectifier



Features

- Glass passivated die construction
- Low forward voltage drop
- High current capability
- · High surge current capability
- Designed for surface mount application
- Plastic material-UL flammability 94V-0
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

• Case: D3K, Molded plastic

Terminals: Plated leads solderable per MIL-STD-202,
 Method 208

Method 208

Polarity: as marked on caseMounting Position: Any

• Lead Free: For RoHS / Lead Free Version

Maximum Ratings: @T_A=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Type Number | Symbol | UG4K B05 | UG4K B10 | UG4K B20 | UG4K B40 | UG4K B60 | UG4K B80 | UG4K B100 | Units |
|---|---|-------------|-------------|-------------|-------------|-------------|-------------|--------------|-------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | $egin{array}{c} V_{RRM} \ V_{RWM} \ V_{DC} \end{array}$ | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| RMS Reverse Voltage | V_{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Average Rectified Without heat sink @T _A = 30°C Output Current With heat sink @T _A = 140°C | | 2.0 4.0 | | | | | | А | |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method) | | | | | А | | | | |

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Electrical Characteristics:

| Type Number | Symbol | UG4K B05 | UG4K B10 | UG4K B20 | UG4K B40 | UG4K B60 | UG4K B80 | UG4K B100 | Units |
|---|---------|-------------|-------------|-------------|-------------|-------------|-------------|--------------|-------|
| Forward Voltage (per element) * @I _F =4.0A | V_{F} | 1.1 | | | V | | | | |
| Peak Reverse Current * @T _A = 25°C | | | μA | | | | | | |
| Typical Junction Capacitance(per leg) (Note 1) | | | | | 21 | | | | pF |

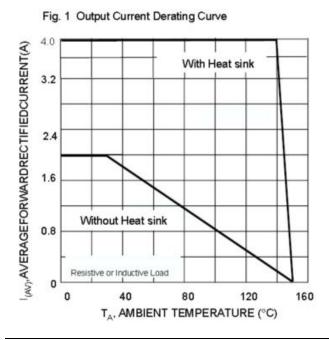
^{*} Pulse width < 300 µs, duty cycle < 2%

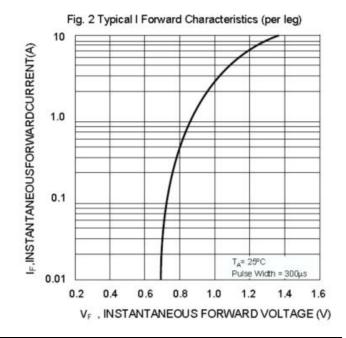
Thermal-Mechanical Specifications:

| Type Number | Symbol | UG4K B05 | UG4K B10 | UG4K B20 | UG4K B40 | UG4K B60 | UG4K B80 | UG4K B100 | Units |
|--|--------------------------------------|-------------|-------------|-------------|-------------|-------------|-------------|--------------|-------|
| Typical Thermal Resistance (per leg)(Note 2) | R _{0JA} R _{0JL} | 55 15 | | | °C/W | | | | |
| Operating and Storage Temperature Range T _J , T _{STG} -55 to | | 5 to +150 |) | | | °C | | | |

Note: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

Ratings and Characteristics Curves





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^{2.} Mounted on glass epoxy PC board with 1.3mm² solder pad.







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Fig. 3 Maximum Peak Forward Surge Current (per leg)

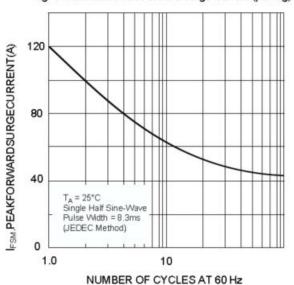


Fig. 5 T ypical Reverse Characteristics (per element)

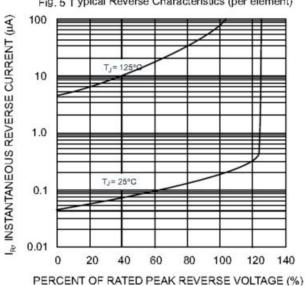


Fig.4 Typical Junction Capacitance Per Diode 100 T_= 25°C = 1.0MHz C_p, JUNCTION CAPACITANCE (pF) 10

REVERSE VOLTAGE (V)

Ordering Information

| Device | Package | Plating | Shipping |
|-----------------------------|--------------|---------|--------------|
| UG4KB05 THRU UG4KB100 | D3K(Pb-Free) | Pure Sn | 37pcs / tube |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

SSG = SSG = Year $\mathsf{W}\mathsf{W}$ = Week = Lot Number UG4KB05 = Type Number

Cautions: Molding resin Epoxy resin UL:94V-0

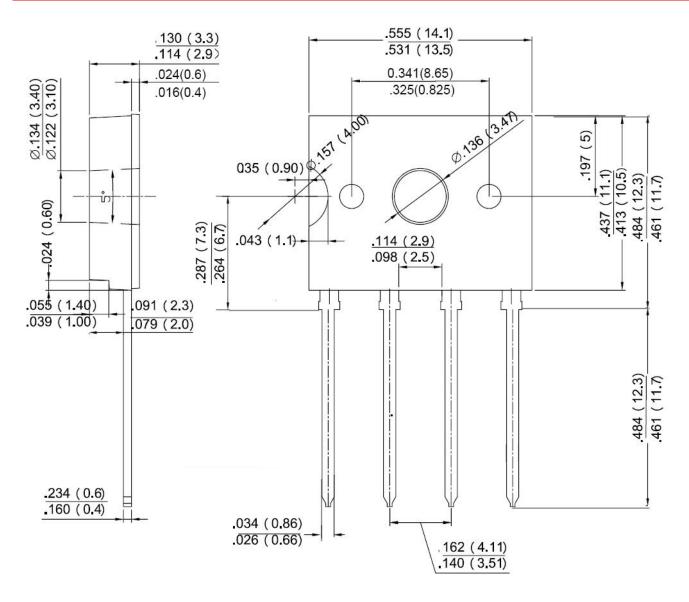
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Mechanical Dimensions D3K (Inches/Millimeters)



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UG4KB05 THRU UG4KB100

Technical Data Data Sheet N1752, Rev. A





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